INTEGRATED CIRCUITS

DATA SHEET

74LVT083.3V Quad 2-input AND gate

Product specification

1996 May 29

IC24 Data Handbook





74LVT08

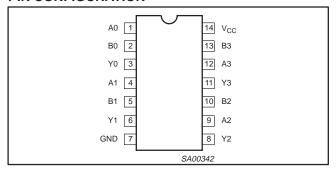
QUICK REFERENCE DATA

SYMBOL	PARAMETER	TEST CONDITIONS T _{amb} = 25°C; GND = 0V	TYPICAL	UNIT	
t _{PLH} t _{PHL}	Propagation delay An or Bn to Yn	$C_L = 50pF;$ $V_{CC} = 3.3V$	3.0 3.4	ns	
C _{IN}	Input capacitance	V _I = 0V or 3.0V	4	pF	
I _{CCL}	Total supply current	Outputs Low; V _{CC} = 3.6V	1	mA	

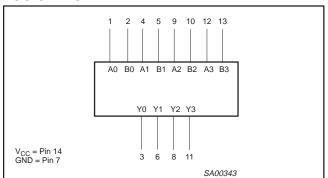
ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	PKG. DWG. #
14-Pin Plastic SO	–40°C to +85°C	74LVT08 D	74LVT08 D	SOT108-1
14-Pin Plastic SSOP	–40°C to +85°C	74LVT08 DB	74LVT08 DB	SOT337-1
14-Pin Plastic TSSOP	-40°C to +85°C	74LVT08 PW	74LVT08PW DH	SOT402-1

PIN CONFIGURATION



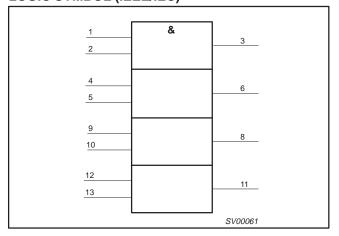
LOGIC DIAGRAM



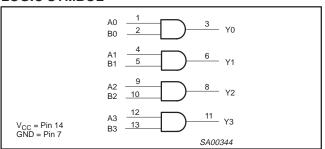
PIN DESCRIPTION

	_	
PIN NUMBER	SYMBOL	NAME AND FUNCTION
1, 2, 4, 5, 9, 10, 12, 13	An-Bn	Data inputs
3, 6, 8, 11	Yn	Data outputs
7	GND	Ground (0V)
14	V _{CC}	Positive supply voltage

LOGIC SYMBOL (IEEE/IEC)



LOGIC SYMBOL



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FUNCTION TABLE

INP	JTS	OUTPUT
Dna	Dnb	Qn
L	L	L
L	Н	L
Н	L	L
Н	Н	Н

NOTES:

H = High voltage level L = Low voltage level

ABSOLUTE MAXIMUM RATINGS1, 2

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +4.6	V
I _{IK}	DC input diode current	V ₁ < 0	-50	mA
VI	DC input voltage ³		-0.5 to +7.0	V
I _{OK}	DC output diode current	V _O < 0	-50	mA
V _{OUT}	DC output voltage ³	Output in Off or High state	-0.5 to +7.0	V
	DC suitaut surrent	Output in High state	-32	A
IOUT	DC output current	Output in Low state	64	mA
T _{stg}	Storage temperature range		-65 to 150	°C

NOTES:

- 1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- absolute-maximum-rated conditions for extended periods may affect device reliability.

 2. The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.
- 3. The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

RECOMMENDED OPERATING CONDITIONS

CVMDOL	DADAMETED	LIM	ITS	LINUT
SYMBOL	PARAMETER	MIN	MAX	UNIT
V _{CC}	DC supply voltage	2.7	3.6	V
VI	Input voltage	0	5.5	V
V _{IH}	High-level input voltage	2.0		V
V _{IL}	Low-level Input voltage		0.8	V
I _{OH}	High-level output current		-20	mA
I _{OL}	Low-level output current		32	mA
Δt/Δν	Input transition rise or fall rate; Outputs enabled	·	10	ns/V
T _{amb}	Operating free-air temperature range	-40	+85	°C

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DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions Voltages are referenced to GND (ground = 0V)

			ı	IMITS		UNIT			
SYMBOL	PARAMETER	TEST CONDITIONS	Temp = -	40°C to	+85°C				
			MIN	TYP ¹	MAX				
V _{IK}	Input clamp voltage	V _{CC} = 2.7V; I _{IK} = -18mA			-1.2	V			
		$V_{CC} = 2.7 \text{ to } 3.6 \text{V}; I_{OH} = -100 \mu\text{A}$	V _{CC} -0.2						
V _{OH}	High-level output voltage	$V_{CC} = 2.7V; I_{OH} = -6mA$	2.4			V			
		$V_{CC} = 3.0V; I_{OH} = -20mA$	2.0						
		V _{CC} = 2.7V; I _{OL} = 100μA			0.2				
V _{OL}	Low-level output voltage	V _{CC} = 2.7V; I _{OL} = 24mA			0.5	V			
		V _{CC} = 3.0V; I _{OL} = 32mA			0.5				
	lamit lands and assessment	$V_{CC} = 0 \text{ or } 3.6V; V_I = 5.5V$			10	^			
l 'ı	Input leakage current	$V_{CC} = 3.6V; V_I = V_{CC} \text{ or GND}$		μΑ					
l _{OFF}	Output off current	$V_{CC} = 0V$; V_I or $V_O = 0$ to 4.5V			±100	μΑ			
Іссн	Ouisseest supply suggest	V_{CC} = 3.6V; Outputs High, V_{I} = GND or V_{CC} , I_{O} = 0			0.02	A			
I _{CCL}	Quiescent supply current	V_{CC} = 3.6V; Outputs Low, V_{I} = GND or V_{CC} , I_{O} = 0	1 2		2	mA			
Δl _{CC}	Additional supply current per input pin ²	V_{CC} = 3V to 3.6V; One input at V_{CC} –0.6V, Other inputs at V_{CC} or GND			0.2	μА			
C _I	Input capacitance	V _I = 3V or 0		4		pF			
Co	Output capacitance	$V_O = 3V \text{ or } 0$		10		pF			

NOTES:

- All typical values are at V_{CC} = 3.3V and T_{amb} = 25°C.
 This is the increase in supply current for each input at the specificed voltage level other than V_{CC} or GND.

AC CHARACTERISTICS

GND = 0V; $t_R = t_F$ = 2.5ns; C_L = 50pF, R_L = 500 Ω ; T_{amb} = -40°C to +85°C.

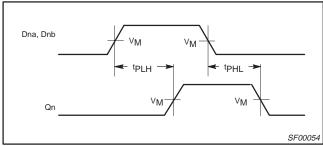
SYMBOL				LIMITS						
	PARAMETER	WAVEFORM	Vcc	$= 3.3 V \pm 0$	V _{CC} = 2.7V	UNIT				
			MIN	TYP ¹	MAX	MAX				
t _{PLH}	Propagation delay An or Bn to Yn	1	1.0 1.0	3.0 3.4	3.9 4.6	4.7 4.8	ns			

NOTE:

1. All typical values are at V_{CC} = 3.3V and T_{amb} = 25°C.

AC WAVEFORMS

 $V_M = 1.5V$, $V_{IN} = GND$ to 2.7V

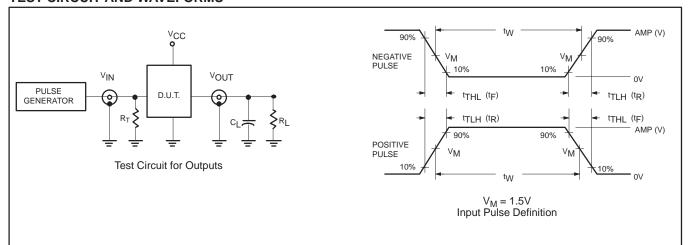


Waveform 1. Propagation Delay for Non-Inverting Outputs

3.3V Quad 2-input AND gate

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TEST CIRCUIT AND WAVEFORMS



5

DEFINITIONS

 R_L = Load resistor; see AC CHARACTERISTICS for value.

 $C_L = Load$ capacitance includes jig and probe capacitance; see AC CHARACTERISTICS for value.

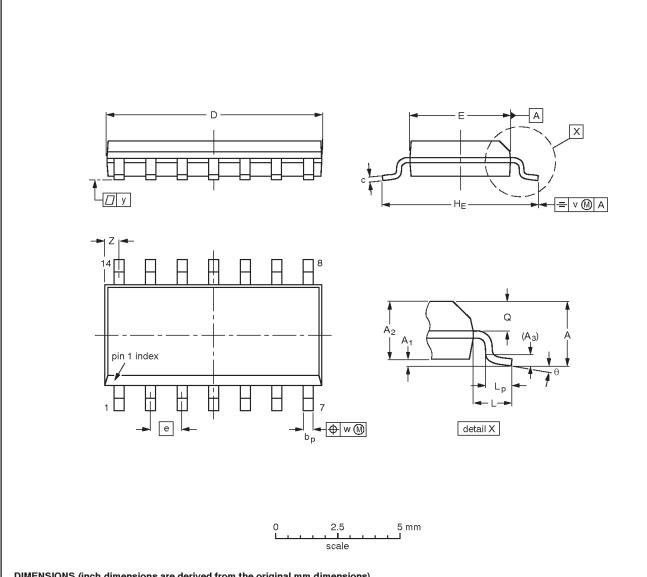
FAMILY	INPUT PULSE REQUIREMENTS											
FAMILI	Amplitude	Rep. Rate	t _W	t _R	t _F							
74LVT	2.7V	≤10MHz	500ns	≤2.5ns	≤2.5ns							

SV00022

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SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁	A ₂	А3	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01	ı	0.0100 0.0075		0.16 0.15	0.050	0.244 0.228	0.041	0.039 0.016		0.01	0.01	0.004	0.028 0.012	0°

Note

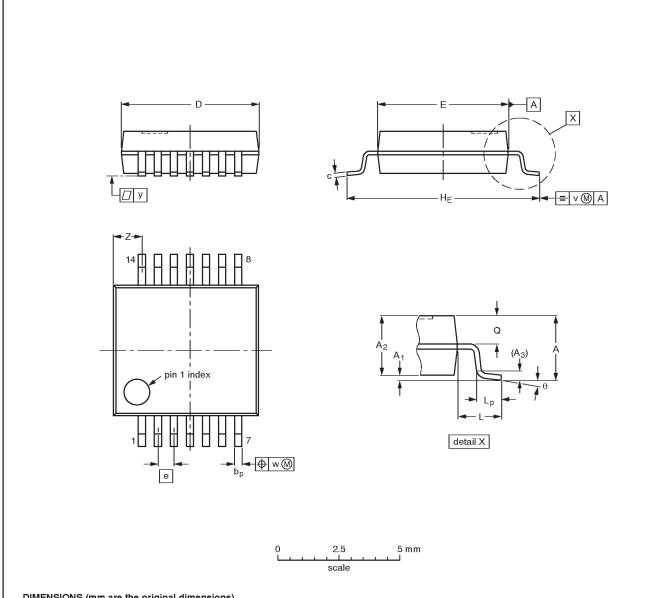
1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOT108-1	076E06S	MS-012AB				95-01-23 97-05-22	

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SSOP14: plastic shrink small outline package; 14 leads; body width 5.3 mm

SOT337-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	bp	c	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Ø	٧	w	у	Z ⁽¹⁾	θ
mm	2.0	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.4 0.9	8° 0°

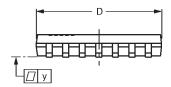
1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

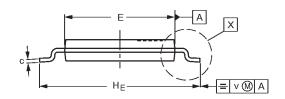
OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT337-1		MO-150AB				-95-02-04 96-01-18

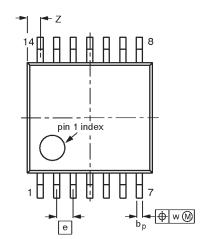
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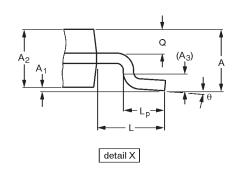
TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

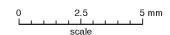
SOT402-1











DIMENSIONS (mm are the original dimensions)

UNIT	A max.	Α1	A ₂	A ₃	bp	С	D ⁽¹⁾	E (2)	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.10	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.72 0.38	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT402-1		MO-153				-94-07-12 95-04-04

3.3V Quad 2-input AND gate

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NOTES

3.3V Quad 2-input AND gate

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DEFINITIONS					
Data Sheet Identification	Product Status	Definition			
Objective Specification	Formative or in Design	This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.			
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